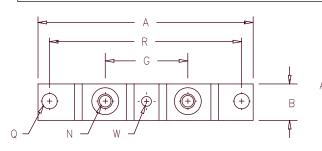
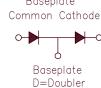
Schottky PowerMod











copper

	Min.	Max.	Min.	Max.	Notes
Baseplate					
A=Common Anode	Α	3.630		92.20	
ο ο	B 0.700	0.800	17.78	20.32	
. 🔻 🔻	C	0.680		17.28	
	E 0.120	0.130	3.05	3.30	
	F 0.490	0.510	12.45	12.95	
Ó	G 1.375 BSC		34.92 BSC		
Baseplate	H 0.010		0.25		
Common Cathode	N				1/4-20
	Q 0.275	0.290	6.99	7.37	Dia.
	R 3.150 BSC 80.01		1 BSC		
Ó	U 0.600		15.24		
. Baseplate	V 0.312	0.340	7.92	8.64	
D=Doubler	W 0.180	0.195	4.57	4.95	Dia.
Notes: Baseplate: Nickel plated	2.100	2.700		7.00	2.4.
busepiute. Mickel pluteu					

Millimeters

Dim. Inches

Microsemi	Working Peak	Repetitive Peak
Catalog Number	Reverse Voltage	Reverse Voltage
CPT60135*	35V	35V
CPT60140*	40V	40V
CPT60145*	45V	45V
*Add Suffix	A for Common An	node, D for Doubler

- Schottky Barrier Rectifier
- Guard Ring Protection
- 600 Amperes/35 to 45 Volts
- 150°C Junction Temperature
- Reverse Energy Tested
- Low Forward Voltage
- ROHS Compliant

Electrical Characteristics

Average forward current per pkg Average forward current per leg Maximum surge current per leg Maximum repetitive reverse current per leg |R(OV) 2 Amps Max peak forward voltage per leg |VFM 0.55 Vol Max peak forward voltage per leg Max peak forward voltage per leg Max peak reverse current per leg Max peak reverse current per leg Typical junction capacitance per leg

F(AV) 600 Amps F(AV) 300 Amps FSM 6000 Amps 0.55 Volts V_{FM} 0.43 Volts ^IRM 3.0 A ^IRM 21 mA C_{J} 15000 pF

 ^{T}C = 94°C, Square wave, $^{R}\Theta$ JC = 0.12°C/W ^{T}C = 94°C, Square wave, $^{R}\Theta$ JC = 0.21°C/W 8.3ms, half sine, $TJ = 175^{\circ}C$ $f = 1 \text{ KHZ}, 25^{\circ}\text{C}, 1 \mu\text{sec}$ square wave $|FM| = 300 \text{A:} \text{TJ} = 25^{\circ}\text{C}$

TFM = 300A:TJ = 150°C VRRM,TJ = 125°C* VRRM,TJ = 25°C $V_R = 5.0V, T_C = 25^{\circ}C$

*Pulse test: Pulse width 300 µsec, Duty cycle 2%

Thermal and Mechanical Characteristics

Storage temp range Operating junction temp range Max thermal resistance per leg Max thermal resistance per pkg Typical thermal resistance (greased) Terminal Torque Mounting Base Torque (outside holes) Mounting Base Torque (center hole) center hole must be torqued first Weight

TSTG ΤJ R OJC ROJC Recs

-55℃ to 150℃ -55℃ to 150℃ 0.21°C/W Junction to case 0.12°C/W Junction to case 0.08°C/W Case to sink 35-40 inch pounds 30-40 inch pounds 8-10 inch pounds

2.8 ounces (78 grams) typical



CPT60135 - CPT60145

Figure 1 Typical Forward Characteristics — Per Leg

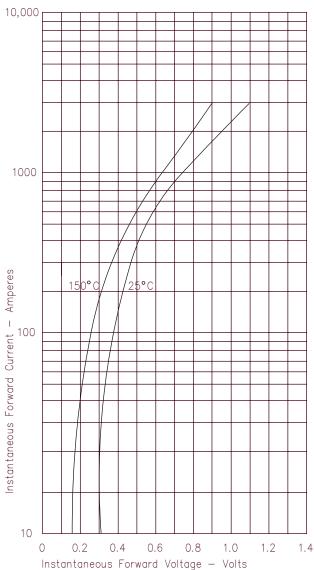


Figure 2 Typical Reverse Characteristics — Per Leg

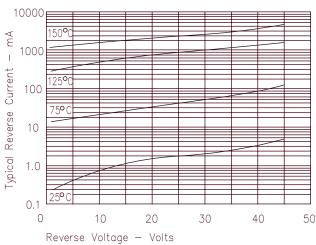


Figure 3
Typical Junction Capacitance — Per Leg

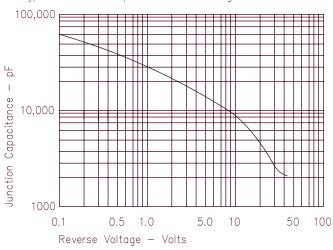


Figure 4
Forward Current Derating — Per Leg

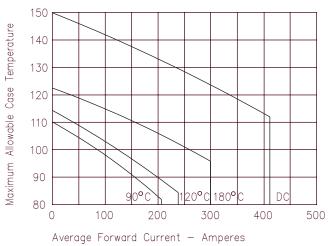
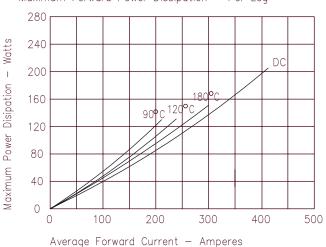


Figure 5 Maximum Forward Power Dissipation — Per Leg





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